

MMCET 2025

2025 International Conference on Materials, Mechanical, and Civil Engineering Technologies

Tokyo, Japan | December 17th-19th, 2025

www.mmccet.com

CALL FOR PAPERS

Important Dates

Submission Deadline - Full Paper
October 20, 2025 (Final)
Submission Deadline - Abstract
October 20, 2025 (Final)
Notification Date - Full Paper
November 05, 2025
Notification Date - Abstract
October 28, 2025
Registration Deadline
November 15, 2025

Organizing Committee

•Conference Chairs

Hisaki Watari, Tokyo Denki University
Kazuo Umemura, Tokyo University of Science

•Program Chairs

Yao Yan, UESTC
John Chia-Yen Lee, National Pingtung University of Science and Technology
Farid Abed, American University of Sharjah

•Program Co-chairs

Payam Shafiqh, Wenzhou University of Technology
Elammaran Jayamani, Swinburne University of Technology

•Publicity Chairs

Mohamed Hussien, Universiti Teknologi Malaysia
Li-Tsung Sheng, National Ilan University

Contact

If you have any question, please feel free to contact our conference secretary:
E-mail: mmccet_conf@163.com

About MMCET 2025

2025 International Conference on Materials, Mechanical, and Civil Engineering Technologies (MMCET 2025) will be held in **Tokyo, Japan** from **December 17th-19th, 2025**. MMCET 2025 is sponsored by Tokyo Denki University, University of Electronic Science and Technology of China, National Pingtung University of Science and Technology, American Society for Electrical Engineering and Universiti Teknologi Malaysia, and the aim of this conference is to bring together researchers and developers from both academia and industry to report on the latest scientific and theoretical advances, to discuss and debate major issues and to demonstrate state-of-the-art systems.

Conference Publication

Accepted full papers will be published in one of the following journals depending on the topic of your paper and submitted for **SCI/SCOPUS/Ei Compendex** index.



(1) *Journal of Nano Research*
Indexed in: SCIE, SCOPUS, EI

(2) *Journal of Biomimetics, Biomaterials and Biomedical Engineering*
Indexed in: ESCI, SCOPUS, EI

(3) *Key Engineering Materials*
Indexed in: SCOPUS, Inspec

(4) *Materials Science Forum*
Indexed in: SCOPUS, Inspec

(5) *Solid State Phenomena*
Indexed in: SCOPUS, Inspec

(6) *Nano Hybrids and Composites*
Indexed in: ESCI, Inspec, CAS

(7) *Advances in Science and Technology*
Indexed in: SCOPUS

(8) *Defect and Diffusion Forum*
Indexed in: SCOPUS, EI

Submission

Full Paper Template:

<https://mmccet.com/downloads/Paper%20Template%20General.docx>

Abstract Template:

<https://mmccet.com/downloads/Abstract%20Template%20General.docx>

Submission Portal:

<https://easychair.org/conferences/?conf=mmccet2025>

Special Issue

The journal **Discover Materials**, under the collection: *Materials in Structural Engineering: Challenges and Innovations under Extreme Loading Conditions*. Indexed in: DOAJ, ESCI and SCOPUS with an **Impact Factor 5.1 (2024)** and CiteScore 2024 of 3.6.



Topics of Interest

•Materials Engineering

Nanomaterials
Composite Materials
Biomaterials
Corrosion Resistance
Additive Manufacturing
Polymer Degradation
Metal Fatigue
Smart Materials

•Mechanical Engineering

Thermodynamic
Fluid Dynamics
Dynamics of Machinery
Mechanical Vibrations
Heat Exchangers
Renewable Energy Systems
CAD/CAM Technologies
Gear Design and Analysis

•Civil Engineering

Structural Engineering
Geotechnical Analysis
Transportation Planning
Water Resource Management
Environmental Impact Assessment
Construction Techniques
Pavement Engineering
Seismic Design